

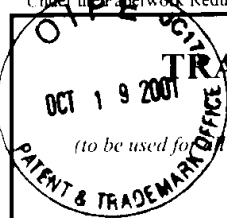
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PTO/SB/21 (08-00)

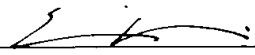
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<b>TRANSMITTAL FORM</b> (to be used for correspondence after initial filing) 	<b>Application Number</b>	09/856,823	
	<b>Filing Date</b>	May 25, 2001	
	<b>First Named Inventor</b>	Shin HISIMATO et al.	
	<b>Group Art Unit</b>	1765	
	<b>Examiner Name</b>	Unassigned	
<b>Total Number of Pages in This Submission</b>		<b>Attorney Docket Number</b>	0819-0559

ENCLOSURES (check all that apply)		
<input type="checkbox"/> Fee Transmittal Form <input type="checkbox"/> Fee Attached <input type="checkbox"/> Amendment / Reply <input type="checkbox"/> After Final <input type="checkbox"/> Affidavits/declaration(s) <input type="checkbox"/> Extension of Time Request <input type="checkbox"/> Express Abandonment Request <input type="checkbox"/> Information Disclosure Statement <input type="checkbox"/> Certified Copy of Priority Document(s) <input type="checkbox"/> Response to Missing Parts/Incomplete Application <input type="checkbox"/> Response to Missing Parts under 37 CFR 1.52 or 1.53	<input type="checkbox"/> Assignment Papers (for an Application) <input type="checkbox"/> Drawing(s) <input type="checkbox"/> Licensing-related Papers <input type="checkbox"/> Petition <input type="checkbox"/> Petition to Convert to a Provisional Application <input type="checkbox"/> Power of Attorney, Revocation Change of Correspondence Address <input type="checkbox"/> Terminal Disclaimer <input type="checkbox"/> Request for Refund <input type="checkbox"/> CD, Number of CD(s) _____	<input type="checkbox"/> After Allowance Communication to Group <input checked="" type="checkbox"/> Request for Corrected Filing Receipt <input checked="" type="checkbox"/> Request for Consideration of Documents Cited in International Search Report  <b>RECEIVED</b> OCT 23 2001 TC 1700
<b>Remarks</b>		<input checked="" type="checkbox"/> The Commissioner is hereby authorized to charge any additional fees required or credit any overpayments to Deposit Account No. 19-2380 for the above identified docket number.

SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT	
Firm or Individual name	<u>Eric J. Robinson, Reg. No. 38,285</u> Nixon Peabody LLP 8180 Greensboro Drive Suite 800 McLean, VA 22012
Signature	
Date	10-15-01

CERTIFICATE OF MAILING		
I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, Washington, DC 20231 on this date: <span style="border: 1px solid black; display: inline-block; width: 100px; height: 20px; vertical-align: middle;"></span>		
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT application of )  
Shin HASIMATO et al. ) Attn: Customer Correction Branch  
Serial No. 09/856,823 )  
Filed: May 25, 2001 )  
For: METHOD FOR FABRICATING )  
SEMICONDUCTOR DEVICE )

Attention: Application Processing Division

**REQUEST FOR CORRECTED FILING RECEIPT**

Honorable Commissioner of Patents  
Washington, D.C. 20231

Sir:

The Filing Receipt received in the above-identified application has errors thereon due to Patent Office error as shown in red on the attached copy.

In view of the above, it is requested that a Corrected Filing Receipt be issued.

Respectfully submitted,



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## UNITED STATES PATENT AND TRADEMARK OFFICE

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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/856,823	05/29/2001 05/25/2001	1765	1130	0819-559	8	16	2

CONFIRMATION NO. 3480

## FILING RECEIPT



\*OC00000006266991\*

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8180 Greensboro Drive  
McLean, VA 22102

Date Mailed: 07/06/2001

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

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## Domestic Priority data as claimed by applicant

THIS APPLICATION IS A 371 OF PCT/JP00/06851 10/03/2000

## Foreign Applications

JAPAN 11-282668 10/04/1999  
JAPAN 2000-263467 08/31/2000

Projected Publication Date: N/A

Non-Publication Request: No

Early Publication Request: No

## Title

for fabricating  
Method of manufacturing semiconductor device